

# 6MBI225U-120



## IGBT Module U-Series 1200V / 225A 6 in one-package

### ■ Features

- High speed switching
- Voltage drive
- Low inductance module structure

### ■ Applications

- Inverter for Motor drive
- AC and DC Servo drive amplifier
- Uninterruptible power supply
- Industrial machines, such as Welding machines

### ■ Maximum ratings and characteristics

#### ● Absolute maximum ratings (at Tc=25°C unless otherwise specified)

Item	Symbol	Conditions	Rating	Unit	
Collector-Emitter voltage	V <sub>CES</sub>		1200	V	
Gate-Emitter voltage	V <sub>GES</sub>		±20	V	
Collector current	I <sub>c</sub>	Continuous	T <sub>c</sub> =25°C	300	A
			T <sub>c</sub> =80°C	225	
	I <sub>cp</sub>	1ms	T <sub>c</sub> =25°C	600	
			T <sub>c</sub> =80°C	450	
	-I <sub>c</sub>			225	
-I <sub>c</sub> pulse			450		
Collector Power Dissipation	P <sub>c</sub>	1 device	1040	W	
Junction temperature	T <sub>j</sub>		+150	°C	
Storage temperature	T <sub>stg</sub>		-40 to +125		
Isolation voltage	between terminal and copper base *1	V <sub>iso</sub>	AC:1min.	2500	VAC
	between thermistor and others *2				
Screw Torque	Mounting *3	-		3.5	N·m
	Terminals *4			4.5	

\*1 : All terminals should be connected together when isolation test will be done.

\*2 : Two thermistor terminals should be connected together, each other terminals should be connected together and shorted to base plate when isolation test will be done.

\*3 :Recommendable value : 2.5 to 3.5 N·m(M5) \*4 :Recommendable value : 3.5 to 4.5 N·m(M6)

#### ● Electrical characteristics (at T<sub>j</sub>=25°C unless otherwise specified)

Item	Symbols	Conditions	Characteristics			Unit	
			Min.	Typ.	Max.		
Zero gate voltage collector current	ICES	V <sub>GE</sub> =0V, V <sub>CES</sub> =1200V	-	-	3.0	mA	
Gate-Emitter leakage current	IGES	V <sub>CES</sub> =0V, V <sub>GE</sub> =±20V	-	-	600	nA	
Gate-Emitter threshold voltage	V <sub>GE(th)</sub>	V <sub>CES</sub> =20V, I <sub>c</sub> =225mA	4.5	6.5	8.5	V	
Collector-Emitter saturation voltage	V <sub>CE(sat)</sub> (terminal)	V <sub>GE</sub> =15V, I <sub>c</sub> =225A	T <sub>j</sub> =25°C	-	2.00	2.35	V
			T <sub>j</sub> =125°C	-	2.25	-	
	V <sub>CE(sat)</sub> (chip)		T <sub>j</sub> =25°C	-	1.75	2.10	
			T <sub>j</sub> =125°C	-	2.00	-	
Input capacitance	C <sub>ies</sub>	V <sub>CES</sub> =10V, V <sub>GE</sub> =0V, f=1MHz	-	25	-	nF	
Turn-on time	t <sub>on</sub>	V <sub>CC</sub> =600V	-	0.36	1.20	μs	
	t <sub>r</sub>	I <sub>c</sub> =225A	-	0.21	0.60		
	t <sub>r(i)</sub>	V <sub>GE</sub> =±15V	-	0.03	-		
Turn-off time	t <sub>off</sub>	R <sub>G</sub> =3 Ω	-	0.37	1.00	μs	
	t <sub>f</sub>		-	0.07	0.30		
Forward on voltage	V <sub>F</sub> (terminal)	V <sub>GE</sub> =0V I <sub>F</sub> =225A	T <sub>j</sub> =25°C	-	1.85	2.15	V
			T <sub>j</sub> =125°C	-	1.95	-	
	V <sub>F</sub> (chip)		T <sub>j</sub> =25°C	-	1.60	1.90	
			T <sub>j</sub> =125°C	-	1.70	-	
Reverse recovery time	t <sub>rr</sub>	I <sub>F</sub> =225A	-	-	0.35	μs	
Lead resistance, terminal-chip*4	R lead		-	1.0	-	mΩ	
Resistance	R	T=25°C	-	5000	-	Ω	
		T=100°C	465	495	520		
B value	B	T=25/50°C	3305	3375	3450	K	

\*4:Biggest internal terminal resistance among arm.

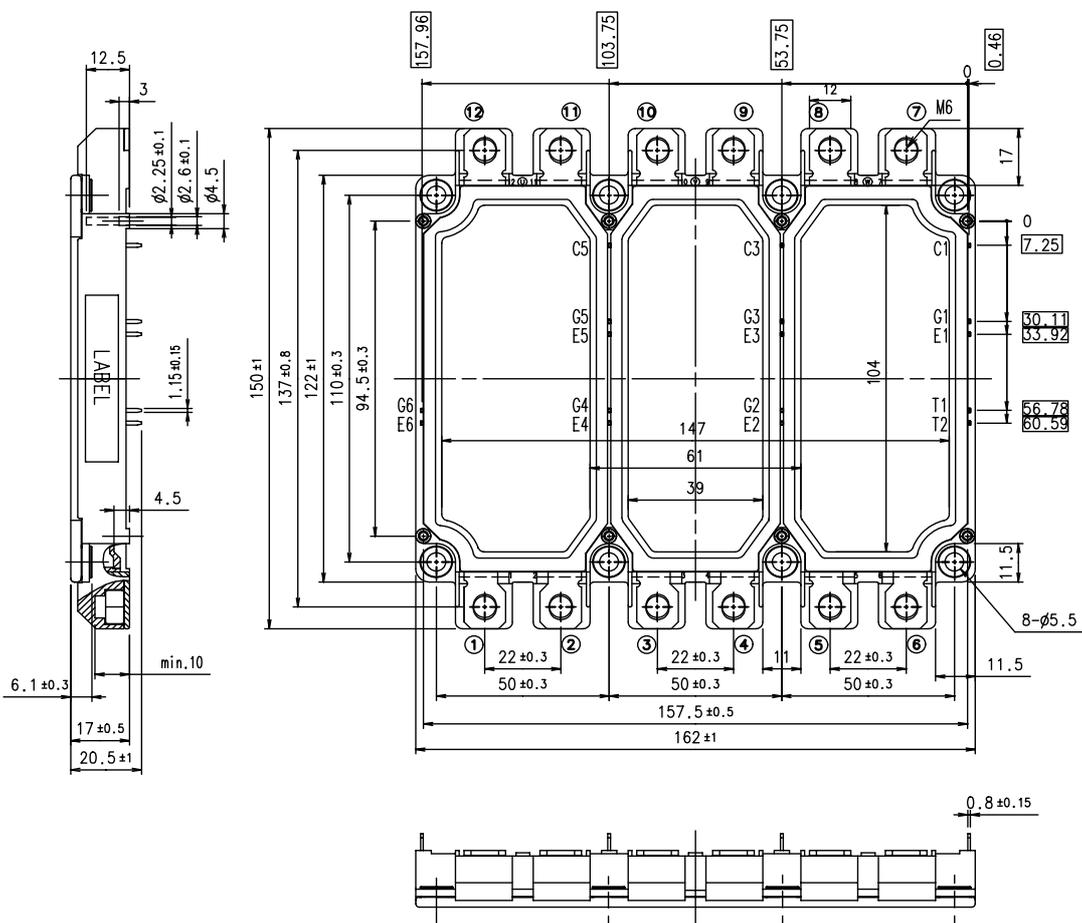
#### ● Thermal resistance characteristics

Items	Symbols	Conditions	Characteristics			Unit
			Min.	Typ.	Max.	
Thermal resistance	R <sub>th(j-c)</sub>	IGBT	-	-	0.12	°C/W
	R <sub>th(j-c)</sub>	FWD	-	-	0.20	°C/W
Contact Thermal resistance	R <sub>th(c-f)</sub> *5	With thermal compound	-	0.0167	-	°C/W

\*5 : This is the value which is defined mounting on the additional cooling fin with thermal compound.

■ Outline Drawings, mm

M629



■ Equivalent Circuit Schematic

